



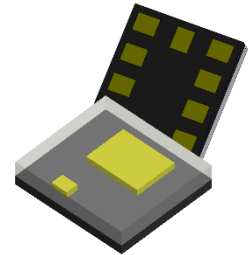
IQS621 Datasheet

Combination sensor with ambient light sensing (ALS), capacitive proximity/touch, Hall-effect sensor & inductive sensing capabilities

The IQS621 ProxFusion™ IC is a multifunctional, ambient light sensing (ALS), capacitive, Hall-effect & inductive sensor designed for applications where any or all of the technologies may be required. The IQS621 is an ultra-low power solution designed for short or long term activations through any of the sensing channels. The IQS621 is fully I²C compatible.

Features

- **Unique combination of sensing technologies:**
 - Capacitive sensing
 - Ambient light sensing (ALS)
 - Hall-effect sensing
 - Inductive sensing
- **Capacitive sensing**
 - 2pF to 200pF external capacitive load capability
 - Fully adjustable sensing options
- **Ambient light sensing (ALS)**
 - Absolute lux output
 - Human eye response compensated
 - 4-bit ALS range output (0 - 10)
 - Dual threshold detection for day/night indication with hysteresis
- **Hall-effect sensing**
 - No external components required
 - Dual direction Hall switch sensor
 - 2 level detection (widely variable)
 - Detection range 1mT – 100mT
- **Inductive sensing**
 - Metal sensing UI with 2 level variable detection and hysteresis
 - Only external sense coil required (PCB trace)
- **Multiple integrated UI options** based on years of experience in sensing on fixed and mobile platforms:
 - Proximity / Touch
 - Proximity wake-up
- **Automatic Tuning Implementation (ATI)** – performance enhancement (10bit)
- Minimal external components
- Standard I²C interface (polling with sub 1ms clock stretching)
- Optional **RDY indication** for event mode operation
- **Low power consumption:** 300uA (50 Hz response, all technologies in use), 2.5uA (low power mode, zoom to scanning mode with wake-up)
- **Event or Streaming mode**
- **Supply voltage: 1.8V to 3.3V**
- **Low profile UOLG - 2.8 x 2.5 x 0.6 - 9-pin package**



UOLG 2.8 x 2.5 x 0.6
9-pin
Representations only

Applications

- Mobile electronics (phones/tablets)
- Home automation & lighting control
- White goods and appliances
- Wearable devices
- Human Interface Devices
- Aftermarket automotive¹

Available Packages	
T _A	UOLG-2.8 x 2.5 x 0.6 – 9N
-40°C to 85°C	IQS621

¹ The part is not automotive qualified.



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List of abbreviations

- ATI – Automatic Tuning Implementation
- LTA – Long term average
- ALS – Ambient Light Sensing
- UI – User interface
- AC – Alternating current
- DSP – Digital signal processing
- RX – Receiving electrode
- LTX – Transmitting electrode
- CS – Sampling capacitor
- NP – Normal power
- LP – Low power
- ULP – Ultra low power
- ACK – I²C Acknowledge condition
- NACK – I²C Not Acknowledge condition



1 Introduction

1.1 ProxFusion™

The ProxFusion™ sensor series provide all of the proven ProxSense® engine capabilities with additional sensors types. A combined sensor solution is available within a single platform.

1.2 Packaging and Pin-Out

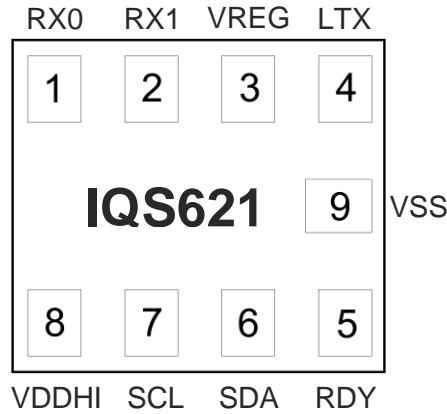


Figure 1.1 IQS621 pin-out (UOLG-2.8 x 2.5 x 0.6 – 9-pin package; device markings may differ)

Table 1.1 Pin-out description

IQS621 in UOLG-2.8 x 2.5 x 0.6 – 9-pin			
Pin	Name	Type	Function
1	RX0	Receiving electrode	Connect to conductive area intended for sensor receiving
2	RX1	Receiving electrode	Connect to conductive area intended for sensor receiving
3	VREG	Regulator output	Requires external capacitor
4	LTX	Transmitter electrode	Connect to conductive area intended for sensor transmitting
5	RDY	Digital Input / Output	RDY (I ² C Ready interrupt signal)
6	SDA	Digital Input / Output	SDA (I ² C Data signal)
7	SCL	Digital Input / Output	SCL (I ² C Clock signal)
8	VDDHI	Supply Input	Supply: 1.8V – 3.3V
9	VSS	Signal GND	Common ground reference



1.3 Reference schematic

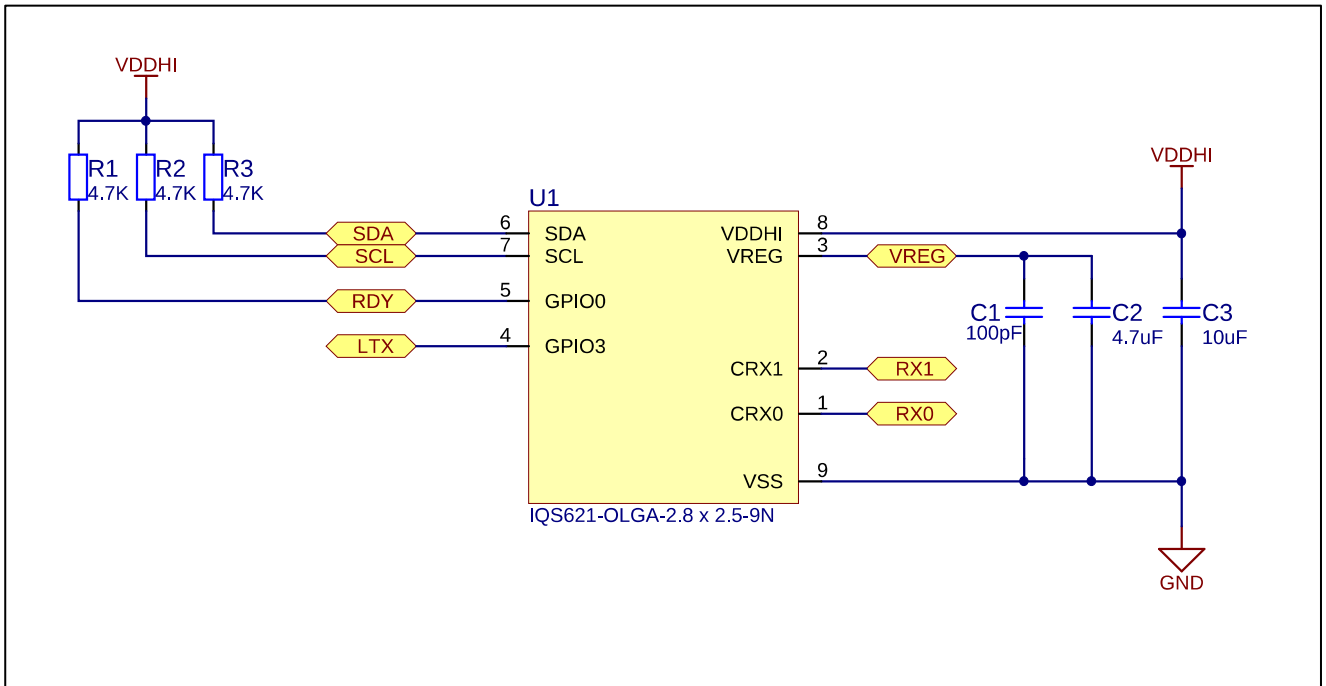


Figure 1.2 IQS621 reference schematic



1.4 Sensor channel combinations

The table below summarizes the IQS621's sensor and channel associations.

Table 1.2 Sensor - channel allocation

	Sensor / UI type	CH0	CH1	CH2	CH3	CH4	CH5	CH6
Capacitive	Self capacitive	○	○					
Inductive	Mutual inductive		●					
ALS	Ambient light sensing				●	●		
Hall-effect	Hall-effect switch UI						● Positive	● Negative
Temperature	Temperature trip and output			●				

Key:

- - Optional implementation
- - Fixed use for UI



2 Capacitive sensing

2.1 Introduction to ProxSense®

Building on the previous successes from the ProxSense® range of capacitive sensors, the same fundamental sensor engine have been implemented in the ProxFusion™ series.

The capacitive sensing capabilities of the IQS621 include:

- Self capacitive sensing.
- Maximum of 2 capacitive channels to be individually configured.
 - Prox and touch adjustable thresholds
 - Individual sensitivity setups
 - Alternative ATI modes
- Discreet button UI:
 - Fully configurable 2 level threshold setup – Traditional Prox & Touch activation levels.
 - Customizable filter halt time

2.2 Channel specifications

The IQS621 provides a maximum of 2 channels available to be configured for capacitive sensing. Each channel can be setup separately according to the channel’s associated settings registers.

There are two distinct capacitive user interfaces available to be used.

- a) Discreet proximity/touch UI (always enabled)

Table 2.1 Capacitive sensing - channel allocation

Sensor/UI type	CH0	CH1	CH2	CH3	CH4	CH5	CH6
Self capacitive	○	○					

Key:

- - Optional implementation
- - Fixed use for UI



2.3 Hardware configuration

In the table below are multiple options of configuring sensing (Rx) and transmitting (Tx) electrodes to realize different implementations (combinations not shown).

Table 2.2 Capacitive sensing hardware description

	Self capacitive
1 button	
2 buttons	



2.4 Software configuration

To be completed.

2.5 Sensor data output and flags

The following registers should be monitored by the master to detect capacitive sensor activations:

- a) The **Global events register (0x11)** will show the IQS621's main events. Bit0 is dedicated to the ProxSense activations.

Global events (0x11)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	-	R	R	R	R	R	R	R
Name	-	POWER MODE EVENT	SYS EVENT	TEMP EVENT	METAL DETECT EVENT	ALS EVENT	HALL EVENT	PROX SENSE EVENT

- b) The **ProxSense UI flags (0x12)** provide more detail regarding the capacitive sensor outputs. An individual prox and touch output bit for channel 0 and 1 is provided in the ProxFusion UI flags register.

ProxSense UI flags (0x12)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	-	-	R	R	-	-	R	R
Name	-	-	CH1_T	CH0_T	-	-	CH1_P	CH0_P



3 Inductive sensing

3.1 Introduction to inductive sensing

The IQS621 provides inductive sensing capabilities in order to detect the presence of metal/metal-type objects. Prox and touch thresholds are widely adjustable and individual hysteresis settings are definable for each.

3.2 Channel specifications

The IQS621 requires 3 sensing lines for mutual inductive sensing. Channel 1 is dedicated to the mutual inductive UI.

There are two distinct inductive user interfaces available to be used.

- a) Discreet proximity/touch UI (always enabled)
- b) Metal detect UI

Table 3.1 Mutual inductive sensor – channel allocation

Mode	CH0	CH1	CH2	CH3	CH4	CH5
Mutual inductive		•				

Key:

- - Optional implementation
- - Fixed use for UI



3.3 Hardware configuration

Rudimentary hardware configurations (to be completed).

Table 3.2 Mutual inductive hardware description

	Mutual inductive
Metal detect UI	<p>The diagram shows a 9-pin connector with pins numbered 1 through 9. Pin 1 is labeled 'RX0' in red, pin 2 is 'RX1', and pin 4 is 'TX0' in blue. Pin 9 is also labeled 'TX0' in blue. Two inductors are shown below the connector. The first inductor is connected to pins 1 and 2. The second inductor is connected to pins 3 and 4. Wires connect the inductors to the corresponding pins on the connector.</p>

3.4 Software configuration

To be completed.



3.5 Sensor data output and flags

The following registers can be monitored by the master to detect inductive sensor related events.

- a) **Global events (0x11)** to prompt for inductive sensor activation. Bit3 denoted as **METAL_DETECT_EVENT** will indicate the detection of a metal object using the inductive sensing.

Global events (0x11)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	-	R	R	R	R	R	R	R
Name	-	POWER MODE EVENT	SYS EVENT	TEMP EVENT	METAL DETECT EVENT	ALS EVENT	HALL EVENT	PROX SENSE EVENT

- b) The **Metal detect UI flags (0x13)** register provides the classic prox/touch two level activation outputs as well as a **signed output** bit to distinguish between whether the counts have risen or fallen below the LTA (direction of counts).

Metal detect UI flags (0x13)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	-	-	-	-	-	R	R	R
Name	-	-	-	-	-	Signed output	TOUCH	PROX

- c) **Metal detect UI output (0x14 - 0x15)** registers will provide a combined 16-bit value to acquire the magnitude of the inductive sensed object.

Metal detect UI output (0x14 - 0x15)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	R	R	R	R	R	R	R	R
Name	Metal detect UI output low byte							
Bit Number	15	14	13	12	11	10	9	8
Data Access	R	R	R	R	R	R	R	R
Name	Metal detect UI output high byte							



4 Ambient light sensing (ALS)

4.1 Introduction to ambient light sensing

The IQS621 employs two light sensitive semi-conductor areas on chip to realise an ambient light sensor. The sensor capabilities includes:

- Human eye response compensated
- 4-bit ALS range output (0 - 10)
- Dual threshold detection for day/night indication with hysteresis
 - 8-bit individual definable light and dark trigger thresholds
 - Dark threshold range: 0 – 1020 Lux in steps of 4 Lux.
 - Light threshold range: 0 – 4080 Lux in steps of 16 Lux.

4.2 Channel specifications

The IQS621 provides 2 dedicated channels to ALS conversions.

Table 4.1 Ambient light sensing - channel allocation

Sensor/UI type	CH0	CH1	CH2	CH3	CH4	CH5	CH6
ALS				•	•		

Key:

- - Fixed use for UI

Please note:

- CS size, multipliers and charge frequency are adjustable.
- Counts on these channels are limited to 8000 counts.
- **Ch3 – ALS channel 1:**
 - Assigned to Wide spectrum ALS.
- **Ch4 – ALS channel 2:**
 - Assigned to narrow spectrum ALS.

4.3 Hardware configuration

To be completed.

4.4 Software configuration

To be completed.



4.5 Sensor data output and flags

The following registers can be monitored by the master to detect ALS related events.

- a) The **ALS EVENT (bit 2)** in the **Global events (0x11)** register are dedicated to ALS related events. This bit will toggle when either one of the three Hall flags is set and is automatically cleared after reading the registers.

Global events (0x11)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	-	R	R	R	R	R	R	R
Name	-	POWER MODE EVENT	SYS EVENT	TEMP EVENT	METAL DETECT EVENT	ALS EVENT	HALL EVENT	PROX SENSE EVENT

- b) The **ALS UI flags (0x16)** register provides a 4 bit ALS Range value to indicate the current ALS reading (**ALS range value bit 0-3**). An additional **LIGHT/DARK bit (bit 7)** is used to indicate the ALS sensor status measured against the two configurable light/dark threshold values in registers 0x80 and 0x81. The user can thus setup his own triggering thresholds for light and dark perceived readings and also incorporate a hysteresis using this UI.

ALS UI flags (0x16)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	R	-	-	-	R	R	R	R
Name	LIGHT / DARK	Reserved			ALS range value			

- c) The **ALS UI output (0x17 - 0x18)** registers provide a 16 bit value of the ALS amplitude in units of Lux as obtained by the current sensor measurement.

ALS UI output (0x17 - 0x18)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	R	R	R	R	R	R	R	R
Name	ALS UI output low byte							
Bit Number	15	14	13	12	11	10	9	8
Data Access	R	R	R	R	R	R	R	R
Name	ALS UI output high byte							



5 Hall-effect sensing

5.1 Introduction to Hall-effect sensing

The IQS621 has two internal Hall-effect sensing plates (on chip). No external sensing hardware is required for Hall-effect sensing.

The Hall-effect measurement is essentially a current measurement of the induced current through the Hall-effect-sensor plates produced by the magnetic field passing perpendicular through each plate.

Advanced digital signal processing are performed to provide sensible output data.

- Two threshold levels are provided (proximity & touch).
- Hall-effect output is linearized by inverting signals.
- North/South field direction indication provided.
- Differential Hall-effect sensing:
 - Removes common mode disturbances
 - North-South field indication

5.2 Channel specifications

Channels 5 and 6 are dedicated to Hall-effect sensing. Channel 5 performs the positive direction measurements and channel 6 will handle all measurements in the negative direction. These two channels are used in conjunction to acquire differential Hall-effect data and will always be used as input data to the Hall-effect UI's.

There is a dedicated Hall-effect user interface:

- a) Hall-effect switch UI

Table 5.1 Hall-effect sensor – channel allocation

Sensor/UI type	CH0	CH1	CH2	CH3	CH4	CH5	CH6
Hall-effect switch UI						• Positive	• Negative

Key:

- - Optional implementation
- - Fixed use for UI



5.3 Hardware configuration

Rudimentary hardware configurations.

Axially polarized magnet (linear movement or magnet presence detection)	
Hall-effect push switch	
Smart cover	
Bar magnet (linear movement and magnet field detection)	
Slide switch	



5.4 Software configuration

To be completed.



5.5 Sensor data output and flags

The following registers can be monitored by the master to detect Hall-effect related events.

- d) The **HALL_EVENT (bit 1)** in the **Global events (0x11)** register are dedicated to Hall-effect related events. This bit will toggle when either one of the three Hall flags is set and is automatically cleared after reading the registers.

Global events (0x11)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	-	R	R	R	R	R	R	R
Name	-	POWER MODE EVENT	SYS EVENT	TEMP EVENT	METAL DETECT EVENT	ALS EVENT	HALL EVENT	PROX SENSE EVENT

- e) The **Hall UI flags (0x19)** register provides the standard two level activation output (prox and touch) as well as a **HALL_N/S** bit to indicate the magnet polarity orientation.

Hall-effect UI flags (0x19)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	-	-	-	-	-	R	R	R
Name	-	-	-	-	-	HALL TOUT	HALL POUT	HALL N/S

- f) The **Hall UI output (0x1A - 0x1B)** registers provide a 16 bit value of the Hall-effect amplitude detected by the sensor.

Hall-effect UI output (0x1A - 0x1B)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	R	R	R	R	R	R	R	R
Name	Hall-effect UI output low byte							
Bit Number	15	14	13	12	11	10	9	8
Data Access	R	R	R	R	R	R	R	R
Name	Hall-effect UI output high byte							



6 Temperature monitoring

6.1 Introduction to temperature monitoring

The IQS621 has an internal temperature monitor to validate IC operating temperature:

- 16-bit Kelvin output
- Temperature change indicator
- Can be used as a temperature change indicator to monitor internal IC temperature and aid in the reliability of other sensor measurements.

The IQS621 uses a linearly proportional to absolute temperature sensor for temperature monitoring. The temperature output is given by,

$$T = \frac{a}{b \cdot CH_2} + c$$

Where *a*, *b* and *c* are constants that are calculated during IC manufacturing. Additionally, the channel setup must be calibrated during testing.

6.2 Channel specifications

To be completed.

Table 6.1 Temperature monitoring – channel allocation

Sensor / UI type	CH0	CH1	CH2	CH3	CH4	CH5	CH6
Temperature trip and output			•				

Key:

- - Optional implementation
- - Fixed use for UI

6.3 Hardware configuration

No hardware configuration is required for temperature monitoring. Only the basic external IC components as implemented in the reference schematic.

A linearly proportional to absolute temperature (PTAT) current is measured by the internal shared sensor engine. The number of counts will lower as temperature increases.

6.4 Software configuration

To be completed.



6.5 Sensor data output and flags

The following registers can be monitored by the master to detect temperature sensor related events.

- a) **Global events (0x11)** to prompt for temperature sensor activation. Bit4 denoted as **TEMP_EVENT** will indicate the detection of a temperature threshold trigger using the temperature sensing.

Global events (0x11)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	-	R	R	R	R	R	R	R
Name	-	POWER MODE EVENT	SYS EVENT	TEMP EVENT	METAL DETECT EVENT	ALS EVENT	HALL EVENT	PROX SENSE EVENT

- b) The **Temperature UI flags (0x1C)** register provides a single bit for temperature trip indication.

Temperature UI flags (0x1C)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Name	Temp Trip	Reserved						

- c) The **Temperature UI output (0x1D - 0x1E)** registers will provide a combined 16-bit value to acquire the magnitude of the temperature sensed.

Temperature UI Output (0x1D - 0x1E)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	R	R	R	R	R	R	R	R
Name	Temperature UI output low byte							
Bit Number	15	14	13	12	11	10	9	8
Data Access	R	R	R	R	R	R	R	R
Name	Temperature UI output high byte							



7 Device clock, power management and mode operation

7.1 Device main oscillator

The IQS621 has a **16MHz** main oscillator (default enabled) to clock all system functionality.

An option exists to reduce the main oscillator to 8MHz. This will result in all system timings, charge transfers and sample rates to be slower by half of the default implementations.

To set this option this:

- As a software setting – Set the System_settings: bit4 = 1, via an I²C command.
- As a permanent setting – Set the OTP option in FG Bank 0: bit2 = 1, using Azoteq USBProg program.

7.2 Device modes

The IQS621 supports the following modes of operation;

- **Normal mode** (Fixed report rate)
- **Low power mode** (Reduced report rate, no UI execution)
- **Ultra-low power mode** (Only channel 0 is sensed for a prox)
- **Halt mode** (Suspended/disabled)

Note: Auto modes must be disabled to enter or exit halt mode.

The device will automatically switch between the different operating modes by default. However this Auto mode feature may be disabled by setting the DSBL_AUTO_MODE bit (Power_mode_settings 0xD2: bit5) to confine device operation to a specific power mode. The POWER_MODE bits (Power_mode_settings 0xD2: bit4-3) can then be used to specify the desired mode of operation.

7.2.1 Normal mode

Normal mode is the fully active sensing mode to function at a fixed report rate specified in the Normal Mode report Rate (0xD3) register. This 8-bit value is adjustable from 0ms – 255ms in intervals of 1ms.

Note: The device's low power oscillator have an accuracy as specified in section 9.

7.2.2 Low power mode

Low power mode is a reduced sensing mode where all channels are sensed but no UI code are executed. The sample rate can be specified in the Low Power Mode report Rate (0xD4) register. The 8-bit value is adjustable from 0ms – 255ms in intervals of 1ms. Reduced report rates also reduce the current consumed by the sensor.

Note: The device's low power oscillator have an accuracy as specified in section 9.

7.2.3 Ultra-low power mode

Ultra-low power mode is a reduced sensing mode where only channel 0 is sensed and no other channels or UI code are executed. Set the EN_ULP_MDE bit (Power_mode_settings: bit6) to enable use of the ultra-low power mode. The sample rate can be specified in the Low Power Mode report Rate (0xD5) register. The 8-bit value is adjustable from 0ms – 4sec in intervals of 16ms.

Wake up will occur on prox detection on channel 0.

7.2.4 Halt mode

Halt mode will suspend all sensing and will place the device in a dormant or sleep state. The device requires an I²C command from a master to explicitly change the power mode out of the halt state before any sensor functionality can continue.



7.2.5 Mode time

The mode time is specified in the Auto mode timer (0xD6) register. The 8-bit value is adjustable from 0ms – 2 min in intervals of 500ms.

7.3 Report rates

7.3.1 Calculation of each mode's report rate

NP_Segment rate

To be completed.

Auto modes change rates

To be completed.

Streaming/event mode rates

To be completed.

7.4 System reset

The IQS621 device monitor's system resets and events.

- a) Every device power-on and reset event will set the Show Reset bit (System flags 0x10: bit7) and the master should explicitly clear this bit by writing it active to acknowledge a valid reset.
- b) The system events will also be indicated with the Global events register's SYS_EVENT bit (Global events 0x11: bit4) if any system event occur such as a reset. This event will continuously trigger until the reset has been acknowledged.



8 Communication

8.1 I²C module specification

The device supports a standard two wire I²C interface with the addition of an RDY (ready interrupt) line. The communications interface of the IQS620 supports the following:

- Streaming data as well as event mode.
- The master may address the device at any time. If the IQS620 is not in a communication window, the device will return an ACK after which clock stretching may be induced until a communication window is entered. Additional communication checks are included in the main loop in order to reduce the average clock stretching time.
- The provided interrupt line (RDY) is open-drain active low implementation and indicates a communication window.

8.2 Device address and sub-addresses

The default device address is **0x44 = DEFAULT_ADDR**.

Alternative sub-address options are definable in the following one-time programmable bits:
OTP Bank0 (bit3; 0; bit1; bit0) = SUB_ADDR_0 to SUB_ADDR_7

- a) Default address: **0x44 = DEFAULT_ADDR OR SUB_ADDR_0**
- b) Sub-address: **0x45 = DEFAULT_ADDR OR SUB_ADDR_1**
- c) Sub-address: **0x46 = DEFAULT_ADDR OR SUB_ADDR_2**
- d) Sub-address: **0x47 = DEFAULT_ADDR OR SUB_ADDR_3**
- e) Sub-address: **0x4C = DEFAULT_ADDR OR SUB_ADDR_4**
- f) Sub-address: **0x4D = DEFAULT_ADDR OR SUB_ADDR_5**
- g) Sub-address: **0x4E = DEFAULT_ADDR OR SUB_ADDR_6**
- h) Sub-address: **0x4F = DEFAULT_ADDR OR SUB_ADDR_7**

8.3 Additional OTP options

All one-time-programmable device options are located in OTP bank 0.

OTP Bank0								
Bit Number	7	6	5	4	3	2	1	0
Name	-	COMMS ATI	-	ALS INC DELAY	SUB ADR 2	8MHz	SUB ADR 0_1	

Bit definitions:

- Bit 6: Communication during ATI
 - 0: No streaming events are generated during ATI
 - 1: Communication continues as setup regardless of ATI state.
- Bit 4: ALS increment delay
 - 0: No delay increment
 - 1: Increment delay enabled
- Bit 2: Main Clock frequency selection
 - 0: Run FOSC at 16MHz
 - 1: Run FOSC at 8MHz
- Bit 3,1,0: I2C sub-address
 - I2C address = 0x44 OR SUB_ADDR

8.4 Recommended communication and runtime flow diagram

The following is a basic master program flow diagram to communicate and handle the device. It addresses possible device events such as output events, ATI and system events (resets).

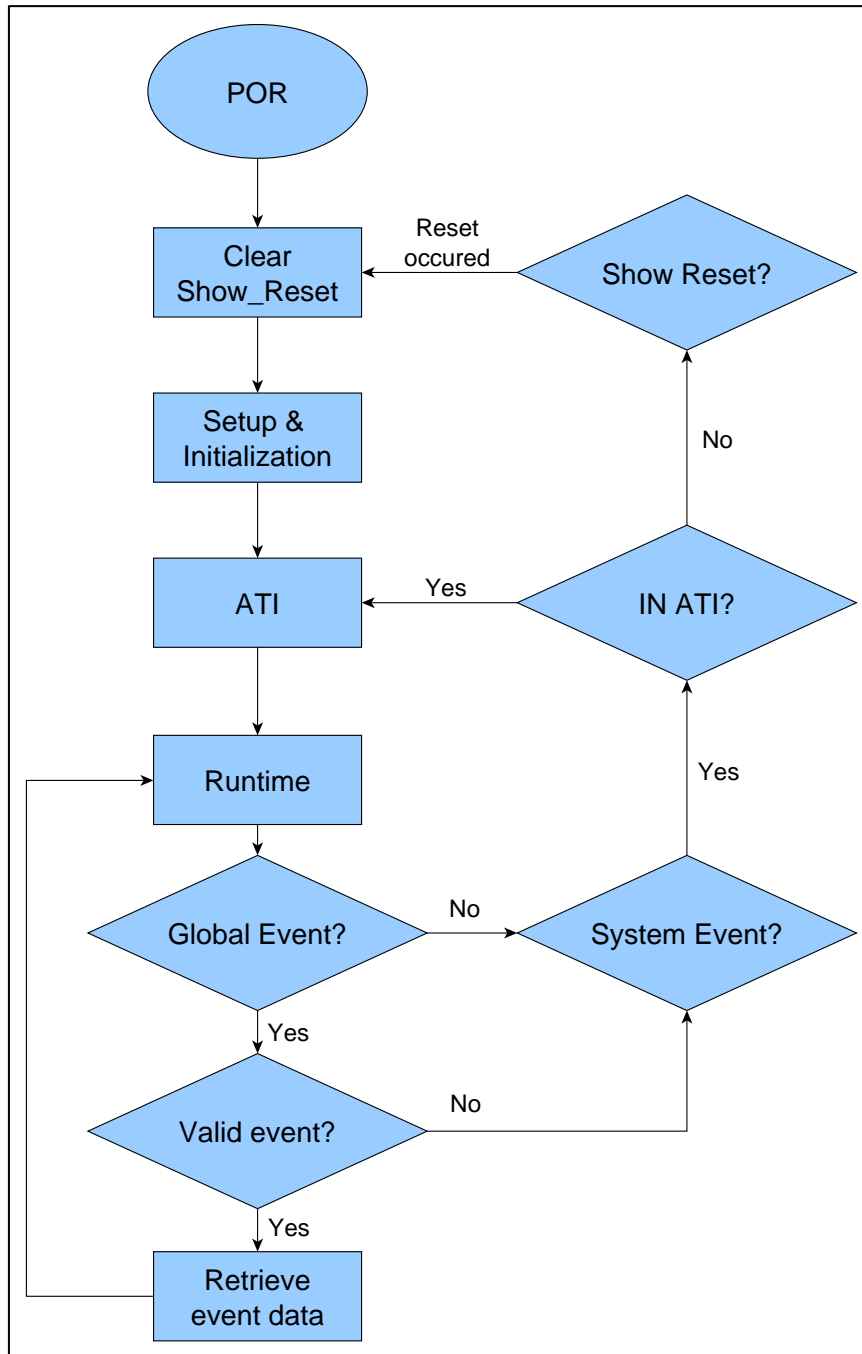


Figure 8.1 Master command structure and runtime event handling flow diagram

It is recommended that the master verifies the status of the System_Flags0 bits to identify events and resets. Detecting either one of these should prompt the master to the next steps of handling the IQS621.

Streaming mode communication is used for detail sensor evaluation during prototyping and/or development phases.

Event mode communication is recommended for runtime use of the IQS621. This reduce the communication on the I²C bus and report only triggered events.



9 Memory map

The full memory map is summarized below. Register groups are explained in the latter subsections.

Table 9.1 IQS621 Memory map index

Full Address	Group Name	Item Name	Data Access
0x00	Device information data	Product number	Read-Only
0x01		Software number	Read-Only
0x02		Hardware number	Read-Only
0x10	Flags and user interface data	System flags	Read-Only
0x11		Global events	Read-Only
0x12		ProxSense UI flags	Read-Only
0x13		Metal detect UI flags	Read-Only
0x14		Metal detect UI output 0	Read-Only
0x15		Metal detect UI output 1	Read-Only
0x16		ALS flags	Read-Only
0x17		ALS output low	Read-Only
0x18		ALS output high	Read-Only
0x19		Hall-effect UI flags	Read-Only
0x1A		Hall-effect UI output 0	Read-Only
0x1B		Hall-effect UI output 1	Read-Only
0x1C		Temperature UI flags	Read-Only
0x1D		Temperature output low	Read-Only
0x1E		Temperature output high	Read-Only
0x20	Channel counts (raw data)	Channel 0 counts low	Read-Only
0x21		Channel 0 counts high	Read-Only
0x22		Channel 1 counts low	Read-Only
0x23		Channel 1 counts high	Read-Only
0x24		Channel 2 counts low	Read-Only
0x25		Channel 2 counts high	Read-Only
0x26		Channel 3 counts low	Read-Only
0x27		Channel 3 counts high	Read-Only
0x28		Channel 4 counts low	Read-Only
0x29		Channel 4 counts high	Read-Only
0x2A		Channel 5 counts low	Read-Only
0x2B		Channel 5 counts high	Read-Only
0x2C		Channel 6 counts low	Read-Only
0x2D		Channel 6 counts high	Read-Only
0x30	LTA values (filtered data)	Channel 0 LTA low	Read-Only
0x31		Channel 0 LTA high	Read-Only
0x32		Channel 1 LTA low	Read-Only
0x33		Channel 2 LTA high	Read-Only
0x40	ProxFusion sensor settings	ProxFusion settings 0_0	Read-Write
0x41		ProxFusion settings 0_1	Read-Write
0x42		ProxFusion settings 1_0	Read-Write
0x43		ProxFusion settings 1_1	Read-Write
0x44		ProxFusion settings 2_0	Read-Write
0x45		ProxFusion settings 2_1	Read-Write
0x46		ProxFusion settings 3_0	Read-Write
0x47		ProxFusion settings 3_1	Read-Write
0x48		ProxFusion settings 4	Read-Write
0x49		ProxFusion settings 5	Read-Write
0x4A		Compensation Ch0	Read-Write
0x4B		Compensation Ch1	Read-Write
0x4C		Multipliers Ch0	Read-Write
0x4D		Multipliers Ch1	Read-Write



0x50	ProxSense UI settings	Prox threshold Ch0	Read-Write
0x51		Touch threshold Ch0	Read-Write
0x52		Prox threshold Ch1	Read-Write
0x53		Touch threshold Ch1	Read-Write
0x54		ProxSense UI halt time	Read-Write
0x60	Metal detect UI settings	Metal detect UI settings	Read-Write
0x61		Metal detect UI filter halt threshold	Read-Write
0x62		Metal detect UI prox threshold	Read-Write
0x63		Metal Detect UI touch threshold	Read-Write
0x70	ALS sensor settings	ALS settings 0	Read-Write
0x71		ALS settings 1	Read-Write
0x72		ALS filter speed	Read-Write
0x73		Multipliers Ch3 Ch4	Read-Write
0x80	ALS UI settings	ALS dark threshold	Read-Write
0x81		ALS light threshold	Read-Write
0x82		ALS to Lux divider	Read-Write
0x83		ALS IR divider	Read-Write
0x90	Hall sensor settings	Hall-effect settings 0	Read-Write
0x91		Hall-effect settings 1	Read-Write
0x92		Compensation Ch4 and Ch5	Read-Write
0x93		Multipliers Ch4 and Ch5	Read-Write
0xA0	Hall switch UI settings	Hall-effect switch UI settings	Read-Write
0xA1		Hall-effect switch UI prox threshold	Read-Write
0xA2		Hall-effect switch UI touch threshold	Read-Write
0xC0	Temperature UI settings	Temperature UI settings	Read-Write
0xC1		Multipliers Ch2	Read-Write
0xC2		Temperature calibration 0	Read-Write
0xC3		Temperature calibration 1	Read-Write
0xD0	Device and power mode settings	System settings	Read-Write
0xD1		Active channels	Read-Write
0xD2		Power mode settings	Read-Write
0xD3		Normal power mode report rate	Read-Write
0xD4		Low power mode report rate	Read-Write
0xD5		Ultra-low power mode report rate	Read-Write
0xD6		Auto mode time	Read-Write
0xD7		Global event mask	Read-Write



9.2 Device Information Data

9.2.1 Product number

Product number (0x00)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	R	R	R	R	R	R	R	R
Name	Device product number							

Bit definitions:

- Bit 7-0: Device product number = D'70'

9.2.2 Software number

Software number (0x01)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	R	R	R	R	R	R	R	R
Name	Device software number							

Bit definitions:

- Bit 7-0: Device software number = D'05'

9.2.3 Hardware number

Hardware number (0x02)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	R	R	R	R	R	R	R	R
Name	Device hardware number							

Bit definitions:

- Bit 7-0: Device hardware number = D'130'



9.3 Flags and user interface data

9.3.1 System flags

System flags (0x10)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	R	-	-	R	R	R	R	R
Name	SHOW RESET	-	-	POWER MODE		IN ATI	EVENT	NP SEG ACTIVE

Bit definitions:

- Bit 7: Reset indicator
 - 0: No reset event
 - 1: A device reset has occurred and needs to be acknowledged.
- Bit 4-3: Current power-mode indicator
 - 00: Normal mode
 - 01: Low power mode
 - 10: Ultra-low power mode
 - 11: Halt Mode
- Bit 2: ATI busy indicator
 - 0: No channels are in ATI
 - 1: One or more channels are in ATI
- Bit 1: Global event indicator
 - 0: No new event to service
 - 1: An event has occurred and should be serviced
- Bit 0: Normal power segment indicator
 - 0: Not performing a normal power update
 - 1: Busy performing a normal power update

9.3.2 Global events

Global events (0x11)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	-	R	R	R	R	R	R	R
Name	-	POWER MODE EVENT	SYS EVENT	TEMP EVENT	METAL DETECT EVENT	ALS EVENT	HALL EVENT	PROX SENSE EVENT

Bit definitions:

- Bit 6: Power mode event flag
 - 0: No event to report
 - 1: A power mode event has occurred and should be handled
- Bit 5: System event flag
 - 0: No event to report
 - 1: A System event has occurred and should be handled
- Bit 4: Temperature event flag
 - 0: No event to report



- 1: A Temperature event has occurred and should be handled
- Bit 3: Metal detect event flag
 - 0: No event to report
 - 1: A Metal detect event has occurred and should be handled
- Bit 2: ALS event flag
 - 0: No event to report
 - 1: An ALS event has occurred and should be handled
- Bit 1: Hall-effect event flag
 - 0: No event to report
 - 1: A Hall-effect event has occurred and should be handled
- Bit 0: ProxSense event flag
 - 0: No event to report
 - 1: A capacitive key event has occurred and should be handled

9.3.3 ProxSense UI flags

ProxSense UI flags (0x12)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	-	-	R	R	-	-	R	R
Name	-	-	CH1_T	CH0_T	-	-	CH1_P	CH0_P

Bit definitions:

- Bit 5: Ch1 touch indicator
 - 0: Delta below touch level
 - 1: Delta above touch level
- Bit 4: Ch0 touch indicator
 - 0: Delta below touch level
 - 1: Delta above touch level
- Bit 1: Ch1 proximity indicator
 - 0: Delta below proximity level
 - 1: Delta above proximity level
- Bit 0: Ch0 proximity indicator
 - 0: Delta below proximity level
 - 1: Delta above proximity level.

9.3.4 Metal detect UI flags

Metal detect UI flags (0x13)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	-	-	-	-	-	R	R	R
Name	-	-	-	-	-	Signed output	TOUCH	PROX

Bit definitions:

- Bit 2: Delta direction signed output
 - 0: Counts rise above the LTA
 - 1: Counts fall below the LTA



- Bit 1: Metal detect touch indicator
 - 0: Field strength below touch level
 - 1: Field strength above touch level
- Bit 0: Metal detect proximity indicator
 - 0: Delta below proximity level
 - 1: Delta above proximity level

9.3.5 Metal detect UI output

Metal detect UI output (0x14/0x15)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	R	R	R	R	R	R	R	R
Name	Metal detect UI output low byte							
Bit Number	15	14	13	12	11	10	9	8
Data Access	R	R	R	R	R	R	R	R
Name	Metal detect UI output high byte							

Bit definitions:

- Bit 15-0: Metal Detect UI output value

9.3.6 ALS UI flags

ALS UI flags (0x16)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	R	-	-	-	R	R	R	R
Name	LIGHT / DARK	Reserved			ALS Range Value			

Bit definitions:

- Bit 7: Light/Dark
 - 0: Light indication
 - 1: Dark indication
- Bit 3-0: ALS Range value
 - 0-10 range value of ALS measurement

9.3.7 ALS UI output

ALS UI output (0x17/0x18)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	R	R	R	R	R	R	R	R
Name	ALS UI Output Low Byte							
Bit Number	15	14	13	12	11	10	9	8
Data Access	R	R	R	R	R	R	R	R



Name	ALS UI Output High Byte
-------------	-------------------------

Bit definitions:

- Bit 15-0: ALS UI output

9.3.8 Hall-effect UI flags

Hall-effect UI flags (0x19)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	-	-	-	-	-	R	R	R
Name	-	-	-	-	-	TOUCH	PROX	HALL N/S

Bit definitions:

- Bit 2: Hall-effect touch indicator
 - 0: Field strength below touch level
 - 1: Field strength above touch level
- Bit 1: Hall-effect proximity indicator
 - 0: Field strength below proximity level
 - 1: Field strength above proximity level
- Bit 0: Hall-effect North South Field indication
 - 0: North field present
 - 1: South field present

9.3.9 Hall-effect UI output

Hall-effect UI output (0x1A/0x1B)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	R	R	R	R	R	R	R	R
Name	Hall-effect UI output low byte							
Bit Number	15	14	13	12	11	10	9	8
Data Access	R	R	R	R	R	R	R	R
Name	Hall-effect UI output high byte							

Bit definitions:

- Bit 15-0: Hall-effect UI output

9.3.10 Temperature UI flags

Temperature UI flags (0x1C)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	R	-	-	-	-	-	-	-
Name	TEMP TRIP	-	-	-	-	-	-	-

Bit definitions:



- Bit 7: Temperature trip indicator
 - 0: Temperature below trip level
 - 1: Temperature above trip level

9.3.11 Temperature output

Temperature output (0x1D/0x1E)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	R	R	R	R	R	R	R	R
Name	Temperature output low byte							
Bit Number	15	14	13	12	11	10	9	8
Data Access	R	R	R	R	R	R	R	R
Name	Temperature output high byte							

Bit definitions:

- Bit 15-0: Temperature output



9.4 Channel counts (raw data)

Channel counts Ch0/1/2/3/4/5/6 (0x20/0x21-0x2C/0x2D)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	R	R	R	R	R	R	R	R
Name	Channel data low byte							
Bit Number	15	14	13	12	11	10	9	8
Data Access	R	R	R	R	R	R	R	R
Name	Channel data high byte							

Bit definitions:

- Bit 15-0: AC filter or raw count value

9.5 LTA values (filtered data)

LTA Ch0/1 (0x30/0x31-0x32/0x33)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	R	R	R	R	R	R	R	R
Name	LTA low byte							
Bit Number	15	14	13	12	11	10	9	8
Data Access	R	R	R	R	R	R	R	R
Name	LTA high byte							

Bit definitions:

- Bit 15-0: LTA filter value



9.6 ProxFusion sensor settings block 1

9.6.1 ProxFusion settings 0

9.6.1.1 Capacitive sensing

ProxFusion settings 0_0/1 (0x40-0x41)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	R/W	R/W	-	-	R/W	R/W	R/W	R/W
Name	Capacitive sensor mode		Internal use	Internal use	TX SELECT		RX SELECT	
Fixed value	0	0	0	0	0	0		

Bit definitions:

- Bit 6-7: Sensor mode
 - 00: Capacitive sensing mode
- Bit 3-2: TX Select
 - 00: TX 0 and TX 1 is disabled
- Bit 0-1: RX select
 - 00: RX 0 and RX 1 is disabled
 - 01: RX 0 is enabled
 - 10: RX 1 is enabled
 - 11: RX 0 and RX 1 is enabled

9.6.1.2 Inductive sensing

ProxFusion settings 0_1 (0x41)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	R/W	R/W	-	R/W	R/W	R/W	R/W	R/W
Name	Inductive sensor mode		Internal use	Multiplier range	TX SELECT		RX SELECT	
Fixed value	1	0	0		0	0	1	1

Bit definitions:

- Bit 7-6: Sensor mode
 - 10: Inductive sensor mode
- Bit 4: Multiplier range
 - 0: Small
 - 1: Large
- Bit 3-2: TX Select
 - 00: TX 0 and TX 1 is disabled
- Bit 1-0: RX Select
 - 11: RX 0 and RX 1 is enabled



9.6.2 ProxFusion settings 1

9.6.2.1 Capacitive sensing

ProxFusion settings 1_0/1 (0x42-0x43)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	-	R/W	R/W	R/W	-	-	R/W	R/W
Name	-	CSz	CHARGE FREQ		Internal use		AUTO ATI MODE	

Bit definitions:

- Bit 6: CS size
 - 0: Prox storage capacitor size is 15 pF
 - 1: Prox storage capacitor size is 60 pF
- Bit 5-4: Charge frequency divider
 - 00: 1/2
 - 01: 1/4
 - 10: 1/8
 - 11: 1/16
- Bit 1-0: Auto ATI Mode
 - 00: ATI disabled
 - 01: Partial ATI (all multipliers are fixed)
 - 10: Semi-partial ATI (coarse multipliers are fixed)
 - 11: Full-ATI

9.6.2.2 Inductive sensing

ProxFusion settings 1_1 (0x43)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	-	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Name	-	CSz	CHARGE FREQ		PROJ BIAS		AUTO ATI MODE	

Bit definitions:

- Bit 6: CS size
 - 0: Prox storage capacitor size is 15pF
 - 1: Prox storage capacitor size is 60pF
- Bit 5-4: Charge frequency divider
 - 00: 1/2
 - 01: 1/4
 - 10: 1/8
 - 11: 1/16
- Bit 3-2: Projected bias / Internal resistor (all modes except prox)
 - 00: 2.5µA / 88kΩ
 - 01: 5µA / 66kΩ
 - 10: 10µA / 44kΩ
 - 11: 20µA / 22kΩ
- Bit 1-0: Auto ATI Mode
 - 00: ATI disabled



- 01: Partial ATI (all multipliers are fixed)
- 10: Semi-Partial ATI (coarse multipliers are fixed)
- 11: Full-ATI

9.6.3 ProxFusion settings 2

9.6.3.1 Capacitive sensing

ProxFusion settings 2_0/1 (0x44 - 0x45)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Name	ATI BASE		ATI TARGET (x32)					

Bit definitions:

- Bit 7-6: Auto ATI base value
 - 00: 75
 - 01: 100
 - 10: 150
 - 11: 200
- Bit 5-0: Auto ATI Target
 - ATI Target is 6-bit value x 32

9.6.3.2 Inductive sensing

ProxFusion settings 2_1 (0x45)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Name	ATI BASE		ATI TARGET (x32)					

Bit definitions:

- Bit 7-6: Auto ATI base value
 - 00: 75
 - 01: 100
 - 10: 150
 - 11: 200
- Bit 5-0: Auto ATI Target
 - ATI Target is 6-bit value x 32

9.6.4 ProxFusion settings 3

9.6.4.1 Capacitive sensing

ProxFusion settings 3_0/1 (0x46-0x47)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	R/W	R/W	R/W	-	R/W	R/W	R/W	-
Name	UP LENGTH SELECT		CS DIV	Internal use	UP LENGTH EN	PASS LENGTH		-



Bit definitions:

- Bit 7-6: Up Length Select (requires **UP_LENGTH_EN = 1** for use)
 - 00: Up length = 0010
 - 01: Up length = 0110
 - 10: Up length = 1010
 - 11: Up length = 1110
- Bit 5: CS divider
 - 0: Normal CS cap size
 - 1: CS cap size 3 times smaller
- Bit 3: Up length select enable
 - 0: Up length select is disabled
 - 1: Up length select is enabled (value in bit 7-6 is used)
- Bit 2-1: Pass length select
 - 00: Pass length = 001
 - 01: Pass length = 011
 - 10: Pass length = 101
 - 11: Pass length = 111

9.6.4.2 Inductive sensing

ProxFusion settings 3_1 (0x47)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	R/W	R/W	R/W	-	R/W	R/W	R/W	-
Name	UP LENGTH SELECT		CS DIV	Internal use	UP LENGTH EN	PASS LENGTH		-

Bit definitions:

- Bit 7-6: Up length select (requires **UP_LENGTH_EN = 1** for use)
 - 00: Up length = 0010
 - 01: Up length = 0110
 - 10: Up length = 1010
 - 11: Up length = 1110
- Bit 5: CS divider
 - 0: Normal CS cap size
 - 1: CS cap size 3 times smaller
- Bit 3: Up length select enable
 - 0: Up length select is disabled
 - 1: Up length select is enabled (value in bit 7-6 is used)
- Bit 2-1: Pass length select
 - 00: Pass length = 001
 - 01: Pass length = 011
 - 10: Pass length = 101
 - 11: Pass length = 111



9.6.5 ProxFusion settings 4

9.6.5.1 Capacitive sensing

ProxFusion settings 4 (0x48)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	-	-	R/W	R/W	R/W	R/W	R/W	R/W
Name	-	Internal use	TWO SIDED EN	ACF DISABLE	LTA BETA		ACF BETA	

Bit definitions:

- Bit 5: Two sided detection
 - 0: Bidirectional detection disabled
 - 1: Bidirectional detection enabled
- Bit 4: Disable AC Filter
 - 0: AC filter enabled
 - 1: AC filter disabled
- Bit 3-2: Long term average beta value
 - 00: 7
 - 01: 8
 - 10: 9
 - 11: 10
- Bit 1-0: AC filter beta value
 - 00: 1
 - 01: 2
 - 10: 3
 - 11: 4

9.6.5.2 Inductive sensing

ProxFusion settings 4 (0x48)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	-	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Name	-	METAL DETECT EN	TWO SIDED EN	ACF DISABLE	LTA BETA		ACF BETA	

Bit definitions:

- Bit 0-1: AC filter beta value
 - 00: 1
 - 01: 2
 - 10: 3
 - 11: 4
- Bit 2-3: Long term average beta value
 - 00: 7
 - 01: 8
 - 10: 9



- 11: 10
- Bit 4: Disable AC filter
 - 0: AC filter enabled
 - 1: AC filter disabled
- Bit 5: Two sided detection
 - 0: Bidirectional detection disabled
 - 1: Bidirectional detection enabled
- Bit 6: Metal detection UI enable
 - 0: Metal detection UI is disabled
 - 1: Metal detection UI is enabled

9.6.6 ProxFusion settings 5

ProxFusion settings 5 (0x49)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	-	-	-	-	-	-	-	-
Name	Internal use							

Bit definitions:

- Bit 7-0: Internal use

9.6.7 Compensation

Compensation Ch0/1/2/3 (0x4A - 0x4B)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Name	Compensation (0-7)							

Bit definitions:

- Bit 7-0: Compensation (7-0)
 - 0-255: Lower 8-bits of the Compensation value.

9.6.8 Multipliers

Multipliers Ch0/1/2/3 (0x4C-0x4D)									
Bit Number	7	6	5	4	3	2	1	0	
Data Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	
Name	Compensation (8-9)		Multiplier coarse			Multiplier fine			

Bit definitions:

- Bit 7-6: Compensation (8-9)
 - 0-3: Upper 2-bits of the Compensation value.
- Bit 5-4: Multiplier coarse
 - 0-3: Coarse multiplier selection
- Bit 3-0: Multiplier fine
 - 0-15: Fine multiplier selection



9.7 ProxFusion UI settings

9.7.1 Prox threshold Ch0/1

Prox Threshold Ch0/1 (0x50/0x52)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Name	Proximity threshold value							

Bit definitions:

- Bit 7-0: Proximity threshold = Proximity threshold value

9.7.2 Touch threshold Ch0/1

Touch Threshold Ch0/1 (0x51/0x53)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Name	Touch threshold value							

Bit definitions:

- Bit 7-0: Touch threshold = Touch threshold value * LTA/ 256

9.7.3 ProxFusion discrete UI halt time

ProxFusion discrete UI halt time (0x54)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Name	Halt time							

Bit definitions:

- Bit 7-0: Halt time in 500ms increments (decimal value x 500ms)



9.8 Metal detect UI settings

9.8.1 Metal detect UI settings

Metal detect UI settings (0x60)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	-	-	R/W	R/W	-	-	R/W	R/W
Name	-	-	Hysteresis_T		-	-	Hysteresis_P	

Bit definitions:

- Bit 5-4: Touch hysteresis
 - 00: Disabled
 - 01: 1/4 of threshold
 - 10: 1/8 of threshold
 - 11: 1/16 of threshold
- Bit 1-0: Proximity hysteresis
 - 00: Disabled
 - 01: 1/4 of threshold
 - 10: 1/8 of threshold
 - 11: 1/16 of threshold

9.8.2 Metal detect UI filter halt threshold

Metal detect UI filter halt threshold (0x61)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Name	Metal detect filter halt threshold value							

Bit definitions:

- Bit 7-0: Filter halt threshold = Metal detect filter halt threshold value

9.8.3 Metal detect UI proximity threshold

Metal detect UI proximity threshold (0x62)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Name	Proximity threshold value							

Bit definitions:

- Bit 7-0: Proximity threshold = Proximity threshold value

9.8.4 Metal detect UI touch threshold

Metal detect UI touch threshold (0x63)								
Bit Number	7	6	5	4	3	2	1	0



Data Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Name	Touch threshold value							

Bit definitions:

- Bit 7-0: Touch threshold = Touch threshold value * 4



9.9 ALS sensor settings

9.9.1 ALS settings 0

ALS settings 0 (0x70)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	-	-	R/W	R/W	R/W	R/W	-	-
Name	-	Internal use	CHARGE FREQ		INC DELAY	CS	-	-

Bit definitions:

- Bit 5-4: Charge frequency divider
 - 00: 1/2
 - 01: 1/4
 - 10: 1/8
 - 11: 1/16
- Bit 3: Inc Delay
 - 0: Pre-charge delay is at default
 - 1: Increase pre-charge delay to improve low light performance
- Bit 2: CS divider size
 - 0: CS divider size default
 - 1: CS divider size increased

9.9.2 ALS settings 1

ALS settings 1 (0x71)									
Bit Number	7	6	5	4	3	2	1	0	
Data Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	
Name	ATI Target (x32)						MULTIPLIER CALIBRATION		

Bit definitions:

- Bit 7-2: ATI target for ALS Ch4 = ATI target x 32
- Bit 1-0: Multiplier calibration
 - 0-3: Multiplier calibration size for ALS sensor calibration

9.9.3 ALS settings filter speed

ALS settings filter speed (0x72)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Name	ALS settings filter speed							

Bit definitions:

- Bit 7-0: ALS settings filter speed
 - 0: Both filter stages are disabled
 - 1: Only the IIR filter is enabled



- 2-255: Windowed minima filter (with window length of 2-255) as well as the IIR is enabled

9.9.4 Multipliers Ch3/4

Multipliers Ch3/4 (0x75)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Name	-		MULTIPLIER COARSE		MULTIPLIER FINE			

Bit definitions:

- Bit 5-4: Multiplier coarse
 - 0-3: Coarse multiplier selection
- Bit 3-0: Multiplier fine
 - 0-15: Fine multiplier selection



9.10 ALS UI settings

9.10.1 ALS dark threshold

ALS dark threshold (0x80)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Name	ALS dark threshold x4 (Lux)							

Bit definitions:

- Bit 7-0: Dark threshold = Dark threshold value x4

9.10.2 ALS light threshold

ALS light threshold (0x81)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Name	ALS Light Threshold x16 (Lux)							

Bit definitions:

- Bit 7-0: Dark Threshold = Dark Threshold value x16

9.10.3 ALS raw to Lux divider

ALS raw to Lux divider (0x82)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Name	ALS raw to Lux divider							

Bit definitions:

- Bit 7-0: ALS raw to Lux divider = ALS raw to Lux divider value (*The default value is loaded from FGB2, 0 disables divider*)

9.10.4 ALS IR compensation

ALS IR compensation (0x83)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Name	ALS IR compensation divider							

Bit definitions:

- Bit 0-7: ALS IR compensation divider = ALS IR compensation divider value (*The default value is loaded from FGB3 lower nibble, 0 disables divider*)



9.11 Hall-effect sensor settings

9.11.1 Hall-effect settings 0

Hall-effect settings 0 (0x90)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	-	-	R/W	R/W	-	-	R/W	R/W
Name	-	-	CHARGE FREQ		reserved		AUTO ATI MODE	

Bit definitions:

- Bit 0-1: Auto ATI Mode
 - 00: ATI disabled
 - 01: Partial ATI (all multipliers are fixed)
 - 10: Semi-Partial ATI (only coarse multipliers are fixed)
 - 11: Full-ATI
- Bit 4-5: Charge frequency divider
 - 00: 1/2
 - 01: 1/4
 - 10: 1/8
 - 11: 1/16

9.11.2 Hall-effect settings 1

Hall-effect settings 1 (0x91)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Name	ATI_BASE		ATI_TARGET (x32)					

Bit definitions:

- Bit 0-5: Auto ATI Target
 - ATI Target is 6-bit value x 32
- Bit 6-7: Auto ATI base value
 - 00: 75
 - 01: 100
 - 10: 150
 - 11: 200

9.11.3 Compensation Ch4/5

Compensation Ch5/6 (0x92)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Name	Compensation (7-0)							

Bit definitions:

- Bit 7-0: Compensation (7-0)



- 7-0: Lower 8-bits of the Compensation value.

9.11.4 Multipliers Ch4/5

Multipliers Ch5/6 (0x93)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Name	Compensation (9-8)		Multipliers coarse		Multipliers fine			

Bit definitions:

- Bit 7-6: Compensation (9-8)
 - 0-3: Upper 2-bits of the Compensation value.
- Bit 5-4: Multipliers coarse
 - 0-3: Coarse multiplier selection
- Bit 3-0: Multipliers fine
 - 0-15: Fine multiplier selection



9.12 Hall-effect switch UI settings

9.12.1 Hall-effect UI settings

Hall-effect UI settings (0xA0)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	-	R/W	R/W	R/W	-	R/W	R/W	R/W
Name		Lin Mode	Hysteresis T		-	Swap Direction	Hysteresis P	

Bit definitions:

- Bit 6: Linearize output
 - 0: Disabled
 - 1: Enabled
- Bit 4-5: Touch hysteresis
 - 00: Disabled
 - 01: 1/4 of threshold
 - 10: 1/8 of threshold
 - 11: 1/16 of threshold
- Bit 2: Swap field direction indication
 - 0: Disabled
 - 1: Enabled
- Bit 0-1: Proximity hysteresis
 - 00: Disabled
 - 01: 1/4 of threshold
 - 10: 1/8 of threshold
 - 11: 1/16 of threshold

9.12.2 Hall-effect UI proximity threshold

Hall-effect UI proximity threshold (0xA1)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Name	Proximity threshold value							

Bit definitions:

- Bit 0-7: Proximity Threshold = Proximity Threshold Value

9.12.3 Hall-effect UI touch threshold

Hall-effect UI touch threshold (0xA2)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Name	Touch threshold value							

Bit definitions:



- Bit 0-7: Touch Threshold = Touch Threshold Value * 4

9.13 Temperature monitoring UI settings

9.13.1 Temperature UI settings

Temperature UI settings (0xC0)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	-	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Name	reserved	RESEED IN PROX	RESEED EN	RESEED THRESHOLD				

Bit definitions:

- Bit 6: Allow temperature reseed while in proximity
 - 0: Reseed in prox disabled
 - 1: Reseed in prox enabled
- Bit 5: Temperature reseed enable
 - 0: Reseed is disabled
 - 1: Reseed is enabled
- Bit 4-0: Temperature reseed threshold = Temperature reseed threshold value

9.13.2 Multiplier channel 2

Multiplier Ch2 (0xC1)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Name	Multiplier Ch2							

Bit definitions:

- Bit 7-0: Multiplier channel 2

9.13.3 Temperature calibration 0

Temperature calibration 0 (0xC2)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Name	Temperature multiplier				Temperature divider			

Bit definitions:

- Bit 7-4: Temperature multiplier = Temperature multiplier value
- Bit 3-0: Temperature divider = Temperature divider value

9.13.4 Temperature calibration 1

Temperature calibration 1 (0xC3)								
Bit Number	7	6	5	4	3	2	1	0



Data Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Name	Temperature offset							

Bit definitions:

- Bit 7-0: Temperature offset = Temperature offset value



9.14 Device and power mode settings

9.14.1 System settings

System settings (0xD0)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	W=1	W=1	R/W	R/W	R/W	R/W	W=1	W=1
Name	SOFT RESET	ACK RESET	EVENT MODE	8MHz	COMMS ATI	ATI BAND	REDO ATI	RESEED

Bit definitions:

- Bit 7: Software Reset (**Set only, will clear when done**)
 - 1: Causes the device to perform a WDT reset
- Bit 6: ACK Reset (**Set only, will clear when done**)
 - 1: Acknowledge that a reset has occurred. This event will trigger until acknowledged.
- Bit 5: Event mode enable
 - 0: Event mode disabled. Default streaming mode communication.
 - 1: Event mode communication enabled.
- Bit 4: Main Clock frequency selection
 - 0: Run FOSC at 16MHz
 - 1: Run FOSC at 8MHz
- Bit 3: Communications during ATI
 - 0: No communications are generated during ATI
 - 1: Communication continue as setup regardless of ATI state.
- Bit 2: Re-ATI Band selection
 - 0: Re-ATI when outside 1/8 of ATI target
 - 1: Re-ATI when outside 1/16 of ATI target
- Bit 1: Redo ATI on all channels (**Set only, will clear when done**)
 - 1: Redo the ATI on all channels
- Bit 0: Reseed all Long-term filters (**Set only, will clear when done**)
 - 1: Reseed all channels

9.14.2 Active channels

Active channels (0xD1)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	-	-	R/W	R/W	R/W	R/W	R/W	R/W
Name	-	-	Ch5	Ch4	Ch3	Ch2	Ch1	Ch0

Bit definitions:

- Bit 6: Ch6 (**note: Ch5 and Ch6 must both be enabled for Hall-effect switch UI to be functional**)
 - 0: Channel is disabled
 - 1: Channel is enabled
- Bit 5: Ch5 (**note: Ch5 and Ch6 must both be enabled for Hall-effect switch UI to be functional**)



- 0: Channel is disabled
- 1: Channel is enabled
- Bit 4: Ch4 (**note: Ch3 and Ch4 must both be enabled for ALS UI to be functional**)
 - 0: Channel is disabled
 - 1: Channel is enabled
- Bit 3: Ch3 (**note: Ch3 and Ch4 must both be enabled for ALS UI to be functional**)
 - 0: Channel is disabled
 - 1: Channel is enabled
- Bit 2: Ch2
 - 0: Channel is disabled
 - 1: Channel is enabled
- Bit 1: Ch1
 - 0: Channel is disabled
 - 1: Channel is enabled
- Bit 0: Ch0
 - 0: Channel is disabled
 - 1: Channel is enabled

9.14.3 Power mode settings

Power mode settings (0xD2)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Name	NP SEG ALL	EN ULP MODE	DSBL AUTO MODE	POWER MODE		NP SEG RATE		

Bit definitions:

- Bit 7: Normal Power Segment bounds check
 - 0: NP-segment check on PRX channels only
 - 1: NP-segment check on all channels
- Bit 6: : Allow auto ultra-low power mode switching
 - 0: ULP is disabled during auto-mode switching
 - 1: ULP is enabled during auto-mode switching
- Bit 5: Disable auto mode switching
 - 0: Auto mode switching is enabled
 - 1: Auto mode switching is disabled
- Bit 4-3: Manually select power mode (**note: bit 5 must be set**)
 - 00: Normal Power mode. The device runs at the normal power rate, all enabled channels and UIs will execute.
 - 01: Low Power mode. The device runs at the low power rate, all enabled channels and UIs will execute.
 - 10: Ultra-Low Power mode. The device runs at the ultra-low power rate, Ch0 is run as wake-up channel. The other channels execute at the NP-segment rate.
 - 11: Halt Mode. No conversions are performed; the device must be removed from this mode using an I2C command.



- Bit 2-0: Normal power segment update rate
 - 000: ½ ULP rate
 - 001: ¼ ULP rate
 - 010: 1/8 ULP rate
 - 011: 1/16 ULP rate
 - 100: 1/32 ULP rate
 - 101: 1/64 ULP rate
 - 110: 1/128 ULP rate
 - 111: 1/256 ULP rate

9.14.4 Normal power mode report rate

Normal power mode report rate (0xD3)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Name	Normal power mode report rate in ms							

Bit definitions:

- Bit 7-0: Normal mode report rate in ms (*note: LPOSC timer has +- 4 ms accuracy*)

9.14.5 Low power mode report rate

Low power mode report rate (0xD4)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Name	Low power mode report rate in ms							

Bit definitions:

- Bit 7-0: Low-power mode report rate in ms (*note: LPOSC timer has +- 4 ms accuracy*)

9.14.6 Ultra-low power mode report rate

Ultra-low power mode report rate (0xD5)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Name	Ultra-low power mode report rate in 16 ms increments							

Bit definitions:

- Bit 7-0: Ultra-low power mode report rate in 16 ms increments (decimal value x 16ms)

9.14.7 Auto mode timer

Auto mode timer (0xD6)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W



Name	Auto mode timer in 500 ms increments
-------------	--------------------------------------

Bit definitions:

- Bit 7-0: Auto modes switching time in 500 ms increments (decimal value x 500ms)

9.14.8 Global event mask

Global event mask (0xD7)								
Bit Number	7	6	5	4	3	2	1	0
Data Access	-	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Name	-	POWER MODE EVENT	SYS EVENT	TEMP EVENT	METAL DETECT EVENT	ALS EVENT	HALL EVENT	PROX SENSE EVENT

Bit definitions:

- Bit 6: Power mode event mask
 - 0: Event is allowed
 - 1: Event is masked
- Bit 5: System event mask
 - 0: Event is allowed
 - 1: Event is masked
- Bit 4: Temperature event mask
 - 0: Event is allowed
 - 1: Event is masked
- Bit 3: Metal detect UI event mask
 - 0: Event is allowed
 - 1: Event is masked
- Bit 2: ALS UI event mask
 - 0: Event is allowed
 - 1: Event is masked
- Bit 1: Hall-effect UI event mask
 - 0: Event is allowed
 - 1: Event is masked
- Bit 0: ProxSense UI event mask
 - 0: Event is allowed
 - 1: Event is masked



10 Electrical characteristics

10.1 Absolute Maximum Specifications

The following absolute maximum parameters are specified for the device:

Exceeding these maximum specifications may cause damage to the device.

Parameter	Absolute maximum
Operating temperature	-40°C to 85°C
Supply Voltage (VDDHI – GND)	3.6V
Maximum pin voltage	VDDHI + 0.5V (may not exceed VDDHI max)
Maximum continuous current (for specific pins)	10mA
Minimum pin voltage	GND - 0.5V
Minimum power-on slope	100V/s
ESD protection	±4kV (Human body model)

10.2 Power On-reset/Brown out

DESCRIPTION	Conditions	PARAMETER	MIN	MAX	UNIT
Power On Reset	V _{DDHI} Slope ≥ 100V/s @25°C	POR	TBC	TBC	V
Brown Out Detect	V _{DDHI} Slope ≥ 100V/s @25°C	BOD	TBC	TBC	V

10.3 Digital input/output trigger levels

DESCRIPTION	Conditions	PARAMETER	MIN	TYPICAL	MAX	UNIT
All digital inputs	VDD = 1.8V	Input low level voltage	TBC	TBC	TBC	V
All digital inputs	VDD = 1.8V	Input high level voltage	TBC	TBC	TBC	V
All digital inputs	VDD = 3.3V	Input low level voltage	TBC	TBC	TBC	V
All digital inputs	VDD = 3.3V	Input high level voltage	TBC	TBC	TBC	V



10.4 Current consumptions

10.4.1 ALS sensing alone

Power mode	Conditions	Report rate	MIN	TYPICAL	MAX	UNIT
NP mode	VDD = 3.3V	76Hz	TBC	111	TBC	uA
NP mode	VDD = 3.3V	50 Hz	TBC	33	TBC	uA
LP mode	VDD = 1.8V	10Hz	TBC	19	TBC	uA
LP mode	VDD = 3.3V		TBC	TBC	TBC	mA
ULP mode	VDD = 1.8V		TBC	TBC	TBC	mA
ULP mode	VDD = 3.3V		TBC	TBC	TBC	mA
Halt mode	VDD = 1.8V		TBC	TBC	TBC	mA
Halt mode	VDD = 3.3V		TBC	TBC	TBC	mA

10.4.2 Capacitive sensing alone

Power mode	Conditions	Report rate	MIN	TYPICAL	MAX	UNIT
NP mode	VDD = 1.8V		TBC	TBC	TBC	mA
NP mode	VDD = 3.3V		TBC	TBC	TBC	mA
LP mode	VDD = 1.8V		TBC	TBC	TBC	mA
LP mode	VDD = 3.3V		TBC	TBC	TBC	mA
ULP mode	VDD = 1.8V		TBC	TBC	TBC	mA
ULP mode	VDD = 3.3V		TBC	TBC	TBC	mA
Halt mode	VDD = 1.8V		TBC	TBC	TBC	mA
Halt mode	VDD = 3.3V		TBC	TBC	TBC	mA

10.4.3 Hall-effect sensing alone

Power mode	Conditions	Report rate	MIN	TYPICAL	MAX	UNIT
NP mode	VDD = 1.8V		TBC	TBC	TBC	mA
NP mode	VDD = 3.3V		TBC	TBC	TBC	mA
LP mode	VDD = 1.8V		TBC	TBC	TBC	mA
LP mode	VDD = 3.3V		TBC	TBC	TBC	mA
ULP mode	VDD = 1.8V		TBC	TBC	TBC	mA
ULP mode	VDD = 3.3V		TBC	TBC	TBC	mA
Halt mode	VDD = 1.8V		TBC	TBC	TBC	mA
Halt mode	VDD = 3.3V		TBC	TBC	TBC	mA

10.4.4 Inductive sensing alone

Power mode	Conditions	Report rate	MIN	TYPICAL	MAX	UNIT
NP mode	VDD = 1.8V		TBC	TBC	TBC	mA
NP mode	VDD = 3.3V		TBC	TBC	TBC	mA
LP mode	VDD = 1.8V		TBC	TBC	TBC	mA
LP mode	VDD = 3.3V		TBC	TBC	TBC	mA
ULP mode	VDD = 1.8V		TBC	TBC	TBC	mA



Power mode	Conditions	Report rate	MIN	TYPICAL	MAX	UNIT
ULP mode	VDD = 3.3V		TBC	TBC	TBC	mA
Halt mode	VDD = 1.8V		TBC	TBC	TBC	mA
Halt mode	VDD = 3.3V		TBC	TBC	TBC	mA

10.4.5 Temperature monitoring alone

Power mode	Conditions	Report rate	MIN	TYPICAL	MAX	UNIT
NP mode	VDD = 1.8V		TBC	TBC	TBC	mA
NP mode	VDD = 3.3V		TBC	TBC	TBC	mA
LP mode	VDD = 1.8V		TBC	TBC	TBC	mA
LP mode	VDD = 3.3V		TBC	TBC	TBC	mA
ULP mode	VDD = 1.8V		TBC	TBC	TBC	mA
ULP mode	VDD = 3.3V		TBC	TBC	TBC	mA
Halt mode	VDD = 1.8V		TBC	TBC	TBC	mA
Halt mode	VDD = 3.3V		TBC	TBC	TBC	mA



10.5 ALS specifications

10.5.1 Human eye response Lux calculation

The spectral response of the human eye does not match that of typical silicone based light sensors. The human eye perceives a peak response in the “green” colour band centred at around 550nm. However silicone based sensors has a maximum response to ambient light typically in the infrared band. To translate the sensor measurement to correlate with the human eye’s natural perceived ambient light sensitivity a dynamic mathematical function is applied.

The follow parameter values are defined for explanatory purposes:

- ***a* → ALS multiplier:**
 - A dynamic multiplier value calculated as in the table below for the specific ALS setup and current ALS value output.
- ***b* → ALS (raw) to Lux divider:**
 - 8-bit value loaded from OTP Bank 2 into register 0x82. This calibration value is determined during IC calibration.
- ***c* → ALS IR compensation divider:**
 - 4-bit value loaded from OTP Bank 2 into register 0x83. This calibration value is determined during IC calibration and can be increased to an 8-bit value if calibration requires a higher value but this will need to be written manually to the register.

The IQS621’s ALS multiplier (parameter *a*) is calculated as specified in the following table.

Table 10.1 ALS multiplier calculation

Inputs					Output
ALS value (0x16: bit3-0)	Coarse multiplier (0x75: bit5-4)	Fine multiplier (0x75: bit3-0)	Charge frequency divider (0x70: bit5-4)	CS size (0x70: bit2)	ALS multiplier <i>a</i>
0	0	MULTIPLIER_CALIBRATION	3	0	1
1	0	MULTIPLIER_CALIBRATION	2	0	2
2	0	MULTIPLIER_CALIBRATION	1	0	4
3	0	MULTIPLIER_CALIBRATION	0	0	8
4	0	MULTIPLIER_CALIBRATION	1	1	16
5	0	MULTIPLIER_CALIBRATION	0	1	32
6	0	(MULTIPLIER_CALIBRATION +1)*2-1	0	1	64
7	0	(MULTIPLIER_CALIBRATION +1)*4-1	0	1	128
8	1	(MULTIPLIER_CALIBRATION +1)*4-1	0	1	384
9	2	(MULTIPLIER_CALIBRATION +1)*4-1	0	1	1152
10	3	(MULTIPLIER_CALIBRATION +1)*4-1	0	1	3456

All the calculations performed on chip are simplified for fixed-point arithmetic. The ALS Lux output is calculated by the following equation:

$$ALS \cong \frac{a}{b} \left(\frac{2^{19}}{CH_4} - \frac{2^{19}}{c \cdot CH_3} \right)$$

ALS in units of Lux (as perceived by a human eye) is calculated using the measurement of channels 3 (ALS-component) & 4 (IR-component) as well as the three compensation parameter *a*, *b* & *c* as defined above.



The output of this function is a 16-bit integer available in the **ALS UI output** register (0x17-0x18).

10.6 Capacitive loading limits

To be completed.

10.7 Hall-effect measurement limits

To be completed.

10.8 Inductive measurement limits

To be completed.

10.9 Temperature measurement limits

To be completed.

11 Package information

11.1 UOLG-2.8 x 2.5 x 0.6 – 9-pin package and footprint specifications

Table 11.1 UOLG-2.8 x 2.5 x 0.6 – 9-pin package dimensions (bottom)

Dimension	[mm]
A	2.500
B	2.800
C	0.400
D	0.500
E	0.430
F	0.330
G	0.115
H	0.120

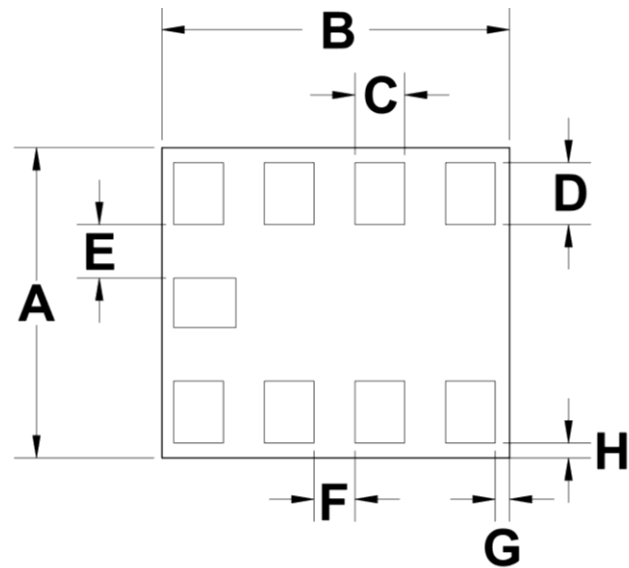


Figure 11.1 OLGA-2.8 x 2.5 x 0.6-9N Package dimensions (bottom view).

Table 11.2 UOLG-2.8 x 2.5 x 0.6 – 9-pin package dimensions (side)

Dimension	[mm]
I	0.600
J	2.800
K	0.370
L	0.230
M	1.560
N	0.620
O	0.400
P	0.145

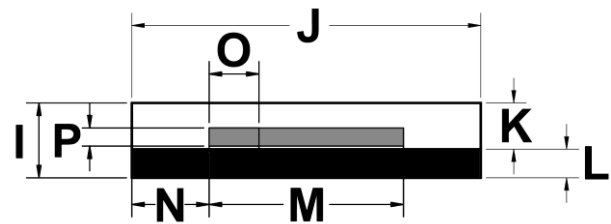


Figure 11.2 OLGA-2.8 x 2.5 x 0.6-9N Package dimensions (side view)

Table 11.3 UOLG-2.8 x 2.5 x 0.6 – 9-pin landing pad dimensions

Dimension	[mm]
Q	0.500
R	0.400
S	0.730
T	0.880
U	1.250
V	1.400

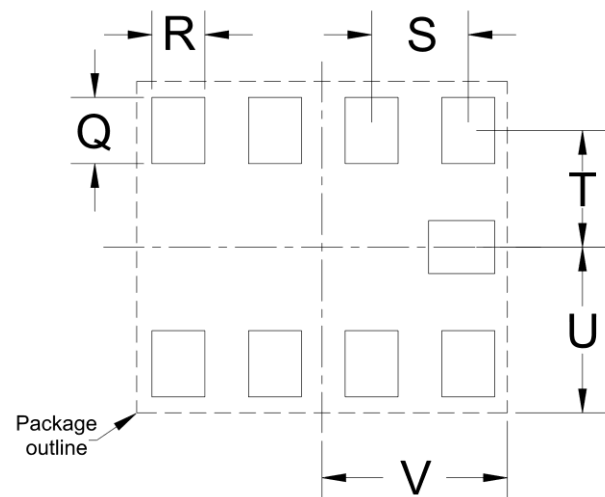


Figure 11.3 OLGA-2.8 x 2.5 x 0.6-9N Landing pad dimensions (viewed from top)



11.2 Device marking and ordering information

To be completed once in production.



11.3 Tape and reel specification

To be completed once in production.



11.4 MSL Level

Moisture Sensitivity Level (MSL) relates to the packaging and handling precautions for some semiconductors. The MSL is an electronic standard for the period in which a moisture sensitive device can be exposed to ambient room conditions (approximately 30°C / 85% RH see J-STD033C for more info) before reflow occur.

Package	Level (duration)
UOLG-2.8 x 2.5 x0.6 -9N	MSL 1 (Unlimited at ≤30°C / 85% RH) Reflow profile peak temperature < 260°C for < 30 seconds



12 Datasheet revisions

12.1 Revision history

Revision 1.0 – First release version

12.2 Errata



Appendix A. Contact information

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The following patents relate to the device or usage of the device: US 6,249,089; US 6,952,084; US 6,984,900; US 7,084,526; US 7,084,531; US 8,395,395; US 8,531,120; US 8,659,306; US 8,823,273; US 9,209,803; US 9,360,510; EP 2,351,220; EP 2,559,164; EP 2,656,189; HK 1,156,120; HK 1,157,080; SA 2001/2151; SA 2006/05363; SA 2014/01541; SA 2015/023634

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